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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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MOS FIELD EFFECT TRANSISTOR μ PA2750GR

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The μ PA2750GR is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management application of notebook computers.

FEATURES

- Dual chip type
- Low on-state resistance

RDS(on)1 = 15.5 m Ω MAX. (VGS = 10 V, ID = 4.5 A)

RDS(on)2 = 21.0 m Ω MAX. (VGS = 4.5 V, ID = 4.5 A)

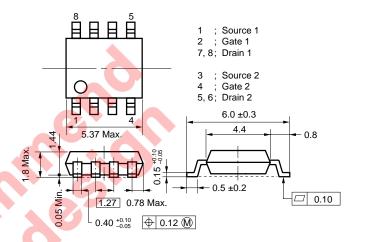
RDS(on)3 = 23.9 m Ω MAX. (Vgs = 4.0 V, ID = 4.5 A)

- Low Ciss: Ciss = 1040 pF TYP. (VDS = 10 V, VGS = 0 V)
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE	
μPA2750GR	Power SOP8	

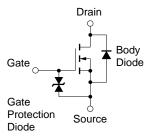
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vss = 0 V)	VDSS	30	V
Gate to Source Voltage (V _{DS} = 0 V)	Vgss	±20	V
Drain Current (DC)	ID(DC)	±9.0	Α
Drain Current (pulse) Note1	ID(pulse)	±36	Α
Total Power Dissipation (1 unit) Note2	Рт	1.7	W
Total Power Dissipation (2 unit) Note2	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note3	IAS	9.0	Α
Single Avalanche Energy Note3	Eas	8.1	mJ

EQUIVALENT CIRCUIT (1/2 circuit)



- **Notes 1.** PW \leq 10 μ s, Duty cycle \leq 1%
 - **2.** TA = 25° C, Mounted on ceramic substrate of 2000 mm² x 2.2 mm
 - 3. Starting Tch = 25°C, VDD = 15 V, RG = 25 Ω , VGS = 20 \rightarrow 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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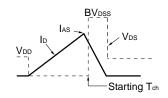


ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

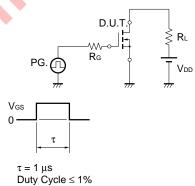
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	V _G S = ±20 V, V _D S = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 4.5 A	5	11		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 4.5 A		12.5	15.5	mΩ
	RDS(on)2	V _G S = 4.5 V, I _D = 4.5 A		16.0	21.0	mΩ
	RDS(on)3	V _G S = 4.0 V, I _D = 4.5 A		17.9	23.9	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1040		pF
Output Capacitance	Coss	V _G S = 0 V		390		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		130		pF
Turn-on Delay Time	td(on)	VDD = 15 V, ID = 4.5 A		13		ns
Rise Time	t r	Vgs = 10 V		10		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		43		ns
Fall Time	t f			9		ns
Total Gate Charge	QG	Vpd = 24 V	2)	21		nC
Gate to Source Charge	Qgs	Vgs = 10 V		3.3		nC
Gate to Drain Charge	QGD	ID = 9.0 A		5.1		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 9.0 A, VGS = 0 V		0.84		V
Reverse Recovery Time	trr	IF = 9.0 A, VGS = 0 V		34		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		34		nC

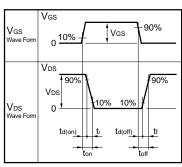
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{Rg} = 25 \Omega \\ \text{Vgs} = 20 \rightarrow 0 \text{ V} \\ \end{array}$



TEST CIRCUIT 2 SWITCHING TIME

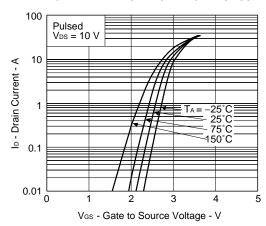


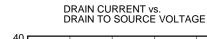


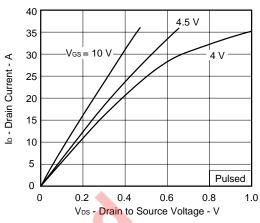
TEST CIRCUIT 3 GATE CHARGE

TYPICAL CHARACTERISTICS (TA = 25°C)

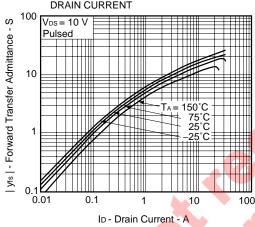




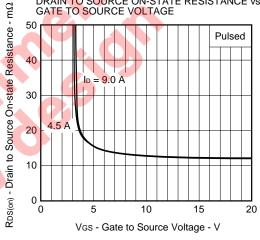




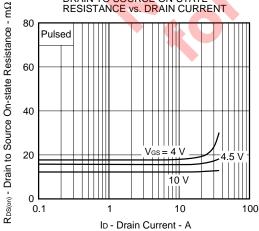




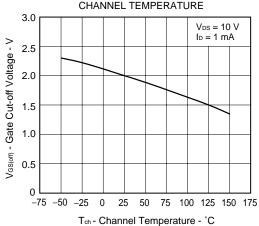
DRAIN TO SOURCE ON-STATE RESISTANCE vs.

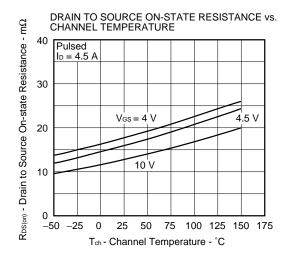


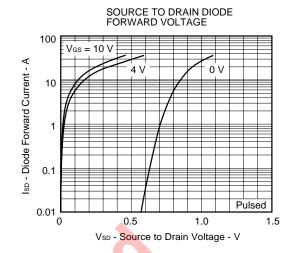
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

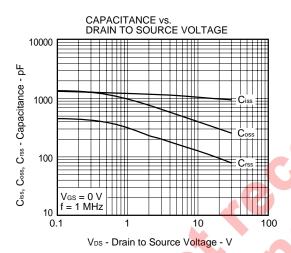


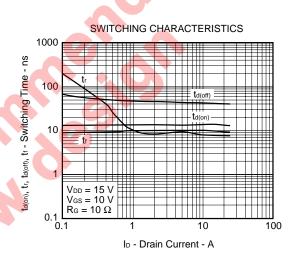
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

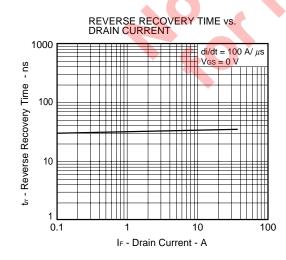


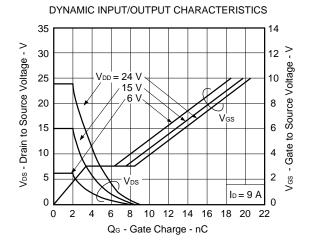


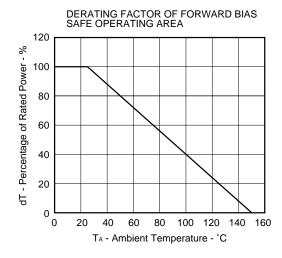


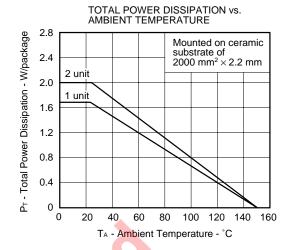




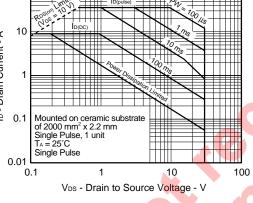


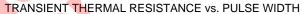




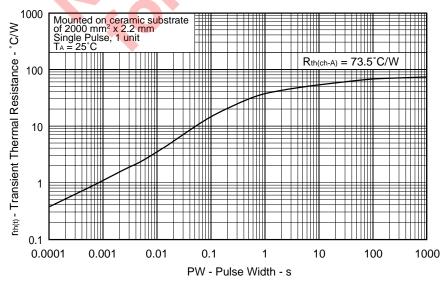


FORWARD BIAS SAFE OPERATING AREA 100 10 Ip - Drain Current - A 0.1 Mounted on ceramic substrate of 2000 mm² x 2.2 mm Single Pulse, 1 unit T_A = 25°C Single Pulse 0.01 0.1 10

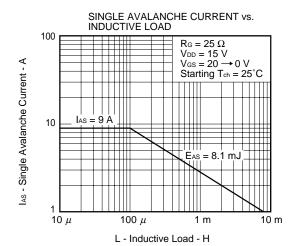


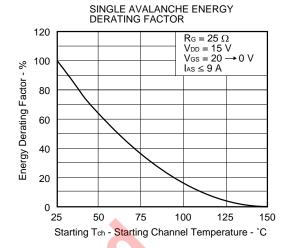


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